

Vishay Semiconductors

# **Insulated Gate Bipolar Transistor** (Warp 2 Speed IGBT), 100 A



SOT-227

| PRODUCT SUMMARY                             |                     |  |  |  |  |  |
|---|---------------------|--|--|--|--|--|
| V <sub>CES</sub>                            | 600 V               |  |  |  |  |  |
| I <sub>C</sub> DC                           | 100 A at 61 °C      |  |  |  |  |  |
| V <sub>CE(on)</sub> typical at 100 A, 25 °C | 2.4 V               |  |  |  |  |  |
| I <sub>F</sub> DC                           | 100 A at 85 °C      |  |  |  |  |  |
| Package                                     | SOT-227             |  |  |  |  |  |
| Circuit                                     | Single Switch Diode |  |  |  |  |  |

#### **FEATURES**

 NPT warp 2 speed IGBT technology with positive temperature coefficient



- Square RBSOA
- HEXFRED® antiparallel diodes with ultrasoft reverse recovery
- · Fully isolated package
- Very low internal inductance (≤ 5 nH typical)
- · Industry standard outline
- UL approved file E78996



· Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

#### **BENEFITS**

- · Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- · Direct mounting to heatsink
- Plug-in compatible with other SOT-227 packages
- Higher switching frequency up to 150 kHz
- Lower conduction losses and switching losses
- · Low EMI, requires less snubbing

| ABSOLUTE MAXIMUM RATINGS         |                   |                                 |      |       |  |
|----------------------------------|-------------------|---------------------------------|------|-------|--|
| PARAMETER                        | SYMBOL            | TEST CONDITIONS                 | MAX. | UNITS |  |
| Collector to emitter voltage     | V <sub>CES</sub>  |                                 | 600  | V     |  |
| Continuous collector current     |                   | T <sub>C</sub> = 25 °C          | 125  |       |  |
| Continuous collector current     | I <sub>C</sub>    | T <sub>C</sub> = 80 °C          | 85   |       |  |
| Pulsed collector current         | I <sub>CM</sub>   |                                 | 300  |       |  |
| Clamped inductive load current   | I <sub>LM</sub>   |                                 | 300  | Α     |  |
| Diode continuous forward current |                   | T <sub>C</sub> = 25 °C          | 160  |       |  |
|                                  | l <sub>F</sub>    | T <sub>C</sub> = 80 °C          | 105  |       |  |
| Peak diode forward current       | I <sub>FM</sub>   |                                 | 200  |       |  |
| Gate to emitter voltage          | V <sub>GE</sub>   |                                 | ± 20 | V     |  |
| Power dissipation, IGBT          | -                 | T <sub>C</sub> = 25 °C          | 447  |       |  |
|                                  | $P_{D}$           | T <sub>C</sub> = 80 °C          | 250  |       |  |
| Power dissipation, diode         | -                 | T <sub>C</sub> = 25 °C          | 313  | W     |  |
|                                  | $P_{D}$           | T <sub>C</sub> = 80 °C          | 175  |       |  |
| Isolation voltage                | V <sub>ISOL</sub> | Any terminal to case, t = 1 min | 2500 | V     |  |



| <b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified) |                                  |   |      |      |       |       |  |
|--|----------------------------------|---|------|------|-------|-------|--|
| PARAMETER  | SYMBOL                           | TEST CONDITIONS   | MIN. | TYP. | MAX.  | UNITS |  |
| Collector to emitter breakdown voltage   | V <sub>BR(CES)</sub>             | $V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$                             | 600  | -    | -     |       |  |
| Collector to emitter valtage   | V                                | V <sub>GE</sub> = 15 V, I <sub>C</sub> = 100 A                              | -    | 2.4  | 2.8   | V     |  |
| Collector to emitter voltage   | V <sub>CE(on)</sub>              | V <sub>GE</sub> = 15 V, I <sub>C</sub> = 100 A, T <sub>J</sub> = 125 °C     | -    | 3    | 3.4   |       |  |
| Gate threshold voltage   | V <sub>GE(th)</sub>              | $V_{CE} = V_{GE}, I_{C} = 250 \mu A$  | 3    | 3.9  | 5     |       |  |
| Temperature coefficient of threshold voltage   | $\Delta V_{GE(th)}/\Delta T_{J}$ | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 1 mA (25 °C to 125 °C) | -    | -10  | -     | mV/°C |  |
| Collector to emitter leakage current   |                                  | V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 600 V                              | -    | 7    | 100   | μΑ    |  |
| Collector to emitter leakage current I <sub>CES</sub>                                |                                  | V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 600 V, T <sub>J</sub> = 150 °C     | -    | 4    | 10    | mA    |  |
| Forward voltage drop   |                                  | I <sub>C</sub> = 100 A, V <sub>GE</sub> = 0 V                               | -    | 1.6  | 2.1   | V     |  |
|  | V <sub>FM</sub>                  | I <sub>C</sub> = 100 A, V <sub>GE</sub> = 0 V, T <sub>J</sub> = 125 °C      | -    | 1.7  | 2     | V     |  |
| Gate to emitter leakage current  | I <sub>GES</sub>                 | V <sub>GE</sub> = ± 20 V  | -    | -    | ± 200 | nA    |  |

| PARAMETER                          | SYMBOL              | TEST CONDITIONS   |   | MIN. | TYP.       | MAX. | UNITS |
|------------------------------------|---------------------|---|---|------|------------|------|-------|
| Total gate charge (turn-on)        | Qg                  |   |   | -    | 460        | 690  |       |
| Gate to emitter charge (turn-on)   | Q <sub>ge</sub>     | $I_C = 100 \text{ A}, V_{CC} = 480 \text{ V}, V_{GE} = 15 \text{ V}$  |   | -    | 160        | 250  | nC    |
| Gate to collector charge (turn-on) | $Q_{gc}$            |   |   | -    | 70         | 130  |       |
| Turn-on switching loss             | E <sub>on</sub>     | I <sub>C</sub> = 100 A, V <sub>CC</sub> = 360 V,  |   | -    | 0.36       | -    |       |
| Turn-off switching loss            | E <sub>off</sub>    | $V_{GE}$ = 15 V, $R_g$ = 5 $\Omega$ ,   |   | -    | 1.42       | -    | mJ    |
| Total switching loss               | E <sub>tot</sub>    | $L = 500 \mu H, T_J = 25 °C$  |   | -    | 1.78       | -    |       |
| Turn-on switching loss             | E <sub>on</sub>     |   | Energy losses include tail and diode recovery (see fig. 18) | -    | 0.52       | -    |       |
| Turn-off switching loss            | E <sub>off</sub>    |   |   | -    | 1.6        | -    |       |
| Total switching loss               | E <sub>tot</sub>    | $I_{C} = 100 \text{ A}, V_{CC} = 360 \text{ V}, \\ V_{GE} = 15 \text{ V}, R_{g} = 5 \Omega, \\ L = 500 \ \mu\text{H}, T_{J} = 125 \ ^{\circ}\text{C}$ |   | -    | 2.12       | -    |       |
| Turn-on delay time                 | t <sub>d(on)</sub>  |   |   | -    | 264        | -    | - ns  |
| Rise time                          | t <sub>r</sub>      |   |   | -    | 54         | -    |       |
| Turn-off delay time                | t <sub>d(off)</sub> |   |   | -    | 257        | -    |       |
| Fall time                          | t <sub>f</sub>      |   |   | -    | 80         | -    |       |
| Reverse bias safe operating area   | RBSOA               | $T_J$ = 150 °C, $I_C$ = 300 A, $R_g$ = 22 $\Omega$ , $V_{GE}$ = 15 V to 0 V, $V_{CC}$ = 400 V, $V_P$ = 600 V, $L$ = 500 $\mu H$                       |   |      | Fullsquare |      |       |
| Diode reverse recovery time        | t <sub>rr</sub>     |   |   | -    | 95         | 120  | ns    |
| Diode peak reverse current         | I <sub>rr</sub>     | I <sub>F</sub> = 50 A, dI <sub>F</sub> /dt = 200 A/µs, V <sub>R</sub> = 200 V - 10  |   |      |            | 13   | Α     |
| Diode recovery charge              | Q <sub>rr</sub>     | -   |   |      | 480        | 780  | nC    |
| Diode reverse recovery time        | t <sub>rr</sub>     | I <sub>F</sub> = 50 A, dI <sub>F</sub> /dt = 200 A/μs,<br>V <sub>R</sub> = 200 V, T <sub>J</sub> = 125 °C   |   | -    | 144        | 185  | ns    |
| Diode peak reverse current         | I <sub>rr</sub>     |   |   | -    | 16         | 19   | Α     |
| Diode recovery charge              | Q <sub>rr</sub>     |   |   | -    | 1136       | 1758 | nC    |



| THERMAL AND MECHANICAL SPECIFICATIONS |       |                                   |                       |      |      |      |       |
|---------------------------------------|-------|-----------------------------------|-----------------------|------|------|------|-------|
| PARAMETER                             |       | SYMBOL                            |                       | MIN. | TYP. | MAX. | UNITS |
| Junction and storage temperature r    | ange  | T <sub>J</sub> , T <sub>Stg</sub> |                       | -40  | -    | 150  | °C    |
| Junction to case                      | IGBT  | В                                 |                       | -    | -    | 0.28 |       |
| Junction to case                      | Diode | - R <sub>thJC</sub>               |                       | -    | -    | 0.4  | °C/W  |
| Case to heatsink                      |       | R <sub>thCS</sub>                 | Flat, greased surface | -    | 0.05 | -    |       |
| Weight                                |       |                                   |                       | -    | 30   | -    | g     |
| Mounting torque                       |       |                                   |                       | -    | -    | 1.3  | Nm    |
| Case style                            |       | SOT-227                           |                       |      |      |      |       |

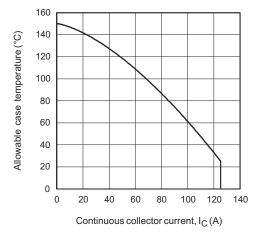


Fig. 1 - Maximum DC IGBT Collector Current vs.

Case Temperature

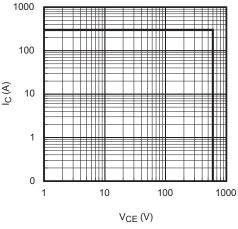


Fig. 2 - IGBT Reverse Bias SOA  $T_J = 150~^{\circ}\text{C}, \, V_{GE} = 15~\text{V}$ 

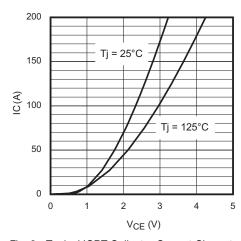
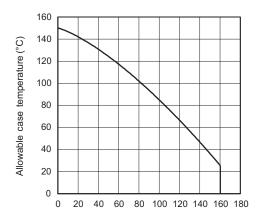


Fig. 3 - Typical IGBT Collector Current Characteristics



 $\label{eq:continuous forward current, IF} \mbox{ Caninuous forward current, IF} (A) \\ \mbox{Fig. 4 - Maximum DC Forward Current vs.} \\ \mbox{ Case Temperature} \\$ 





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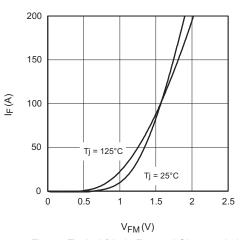


Fig. 5 - Typical Diode Forward Characteristics

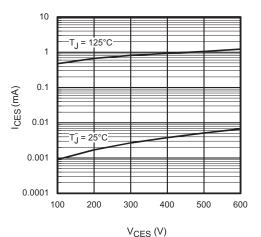


Fig. 6 - Typical IGBT Zero Gate Voltage Collector Current

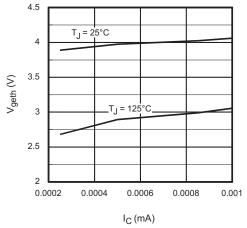


Fig. 7 - Typical IGBT Threshold Voltage

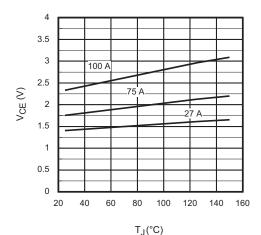


Fig. 8 - Typical IGBT Collector to Emitter Voltage vs. Junction Temperature,  $V_{GE} = 15 \text{ V}$ 

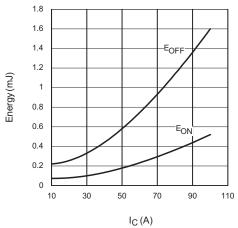


Fig. 9 - Typical IGBT Energy Loss vs. I<sub>C</sub>  $T_J$  = 125 °C, L = 500  $\mu$ H, V<sub>CC</sub> = 360 V,  $R_g$  = 5  $\Omega$ , V<sub>GE</sub> = 15 V

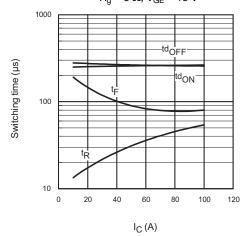
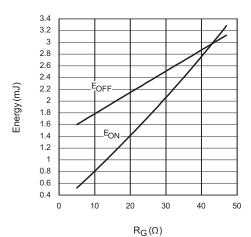


Fig. 10 - Typical IGBT Switching Time vs.  $I_C$   $T_J$  = 125 °C, L = 500  $\mu$ H,  $V_{CC}$  = 360 V,  $R_g$  = 5  $\Omega$ ,  $V_{GE}$  = 15 V



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Fig. 11 - Typical IGBT Energy Loss vs.  $R_g$   $T_J$  = 125 °C,  $I_C$  = 100 A, L = 500  $\mu$ H,  $V_{CC}$  = 360 V,  $V_{GE}$  = 15 V

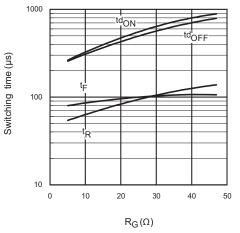


Fig. 12 - Typical IGBT Switching Time vs.  $R_g$   $T_J$  = 125 °C, L = 500  $\mu H,\ V_{CC}$  = 360 V,  $I_C$  = 100 A,  $V_{GE}$  = 15 V

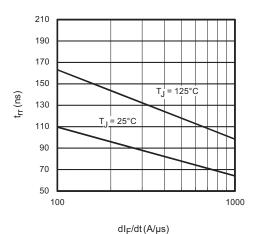


Fig. 13 - Typical  $t_{rr}$  diode vs.  $dI_F/dt$   $V_{RR} = 200 \text{ V}, I_F = 50 \text{ A}$ 

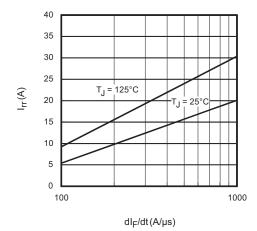


Fig. 14 - Typical  $I_{rr}$  diode vs.  $dI_F/dt$  $V_{RR} = 200 \text{ V}$ ,  $I_F = 50 \text{ A}$ 

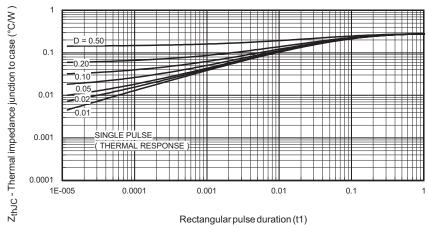


Fig. 15 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics (IGBT)





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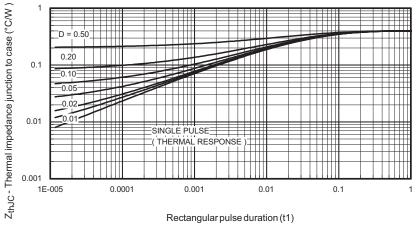
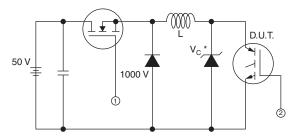


Fig. 16 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics (diode)



- $^{\star}$  Driver same type as D.U.T.; V  $_{\rm C}$  = 80 % of V  $_{\rm ce(max)}$   $^{\star}$  Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain Id

Fig. 17a - Clamped Inductive Load Test Circuit

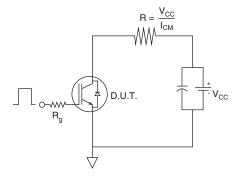


Fig. 17b - Pulsed Collector Current Test Circuit

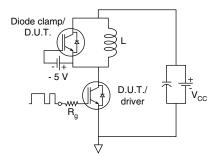


Fig. 18a - Switching Loss Test Circuit

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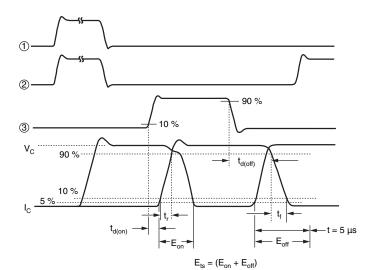
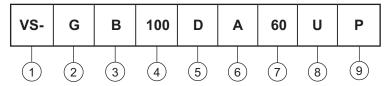


Fig. 18b - Switching Loss Waveforms Test Circuit

#### **ORDERING INFORMATION TABLE**

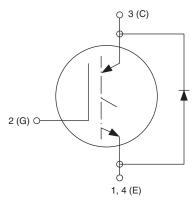
Device code

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- 1 Vishay Semiconductors product
- Insulated Gate Bipolar Transistor (IGBT)
- 3 B = IGBT Generation 5
- Current rating (100 = 100 A)
- 5 Circuit configuration (D = Single switch with antiparallel diode)
- 6 Package indicator (A = SOT-227)
- 7 Voltage rating (60 = 600 V)
- 8 Speed/type (U = Ultrafast IGBT)
- 9 Totally lead (Pb)-free

#### **CIRCUIT CONFIGURATION**



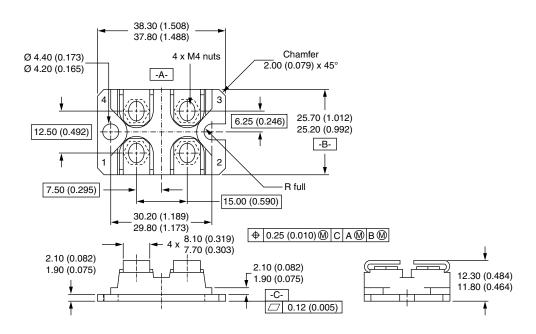
| LINKS TO RELATED DOCUMENTS                 |                          |  |  |  |  |
|--|--------------------------|--|--|--|--|
| Dimensions <u>www.vishay.com/doc?95036</u> |                          |  |  |  |  |
| Packaging information                      | www.vishay.com/doc?95037 |  |  |  |  |



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#### **SOT-227**

#### **DIMENSIONS** in millimeters (inches)



#### Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- · Controlling dimension: millimeter

Document Number: 95036 Revision: 28-Aug-07

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